

SESSION 18

THE REAL WORLD OF MIC PACKAGING (PANEL)

F. J. Rosenbaum, Moderator
Washington University
St. Louis, Missouri

(Sponsored by MTT-6 Committee on MICs)

Friday, June 14
0900-1200 Space Science Building,
Room 2

AIRCOM, INC.
DESIGNERS and MANUFACTURERS
of
A STANDARD LINE of
PASSIVE WAVEGUIDE COMPONENTS
Tel. 603 473 2323
MAIN ST., UNION, N. H. 03887